

100 nA, 12 kV, 50 ms/pixel

Considerations:

Precision = counts

Accuracy = accurate net intensity background measurement peak measurement interferences on peak and background - elements in the phase of interest - lines fluoresced from adjacent phases or

compositional domains

Precision = current and count time – *Not the problem*

Improved sensitivity (lower MDL), more efficient spectrometers, higher, more stable currents

Accuracy =

Sample preparation and coating are critical Map! Know the layout of the environment High resolution WDS scanning

evaluation must be commensurate with the sensitivity of the analysis!

Minimize drift (contamination, dynamic charge effects, source stability, etc.) and beam damage (high current density)

Background measurement – must account for background shape Spectrometer efficiency Natural Bremmstrahlung Watch for 'holes'

Peak measurement - watch for interferences – peak tails Accurate interference corrections

Be wary of fluorescence at a distance Induced by characteristic radiation Induced by continuum – especially from high Z phases Zr in rutile (thermometry)

Relatively low spatial resolution analysis

20 kV, 200nA, 5 spectrometer integration, 600 sec. acquisitions *Integrating PET, two LPETs, and 2 VLPETs*

= Single point detection limit of 14ppm (3σ) for Zr

= Grain average yields an overall detection limit of 3 ppm (3σ) for 15 points, and 4 ppm (3σ) for 10 points

Accuracy =

Sample preparation and coating are critical

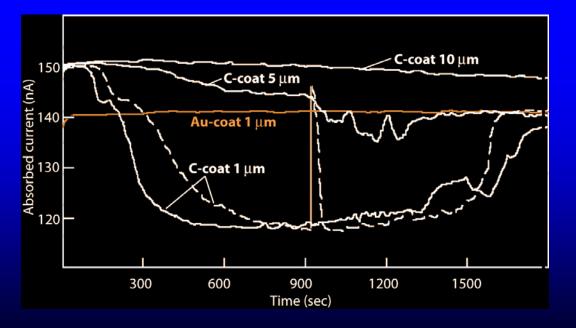
A few brief thoughts on sample preparation –

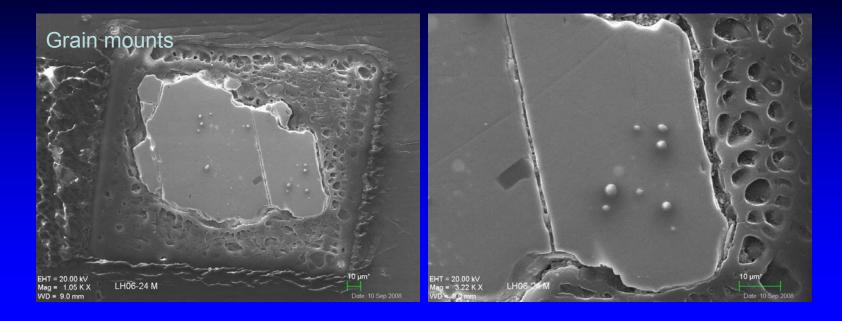
Trace element analysis (precision = counts)

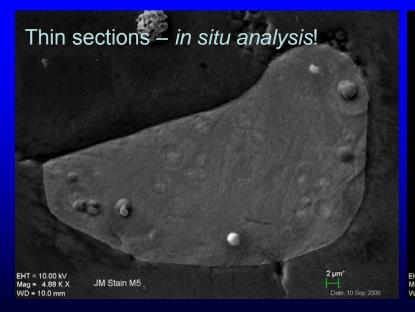
very high current (voltage?) very long count times

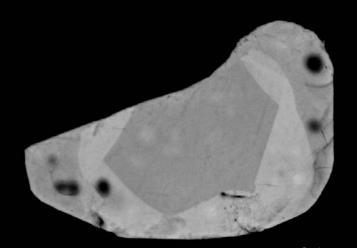
Must consider the sample

- High current density Beam damage Internal charge effects
- Boundaries and edge preservation







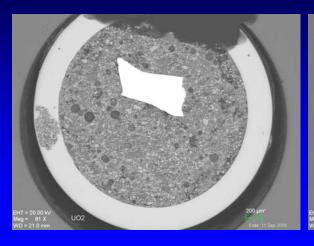


EHT = 20.00 kV Mag = 5.23 K X JM Stain M5 WD = 8.5 mm 2 µm* ⊢ Date :10 Sep 2008

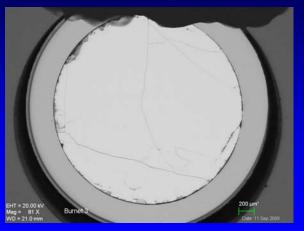
Grain mounts

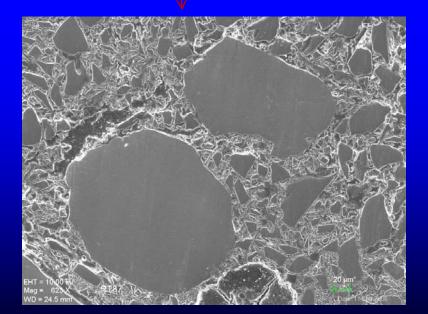
Potting - Casting ceramics

Micro-drill, press fit, and Ni-epoxy



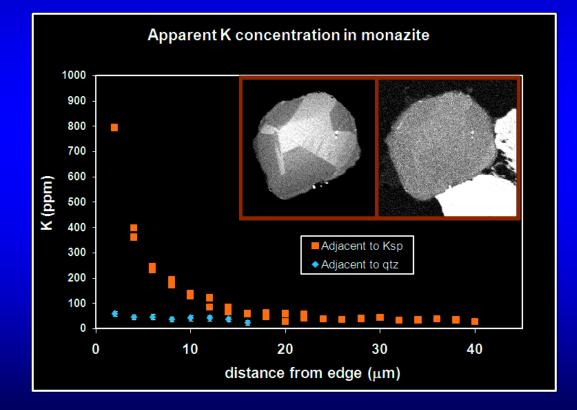


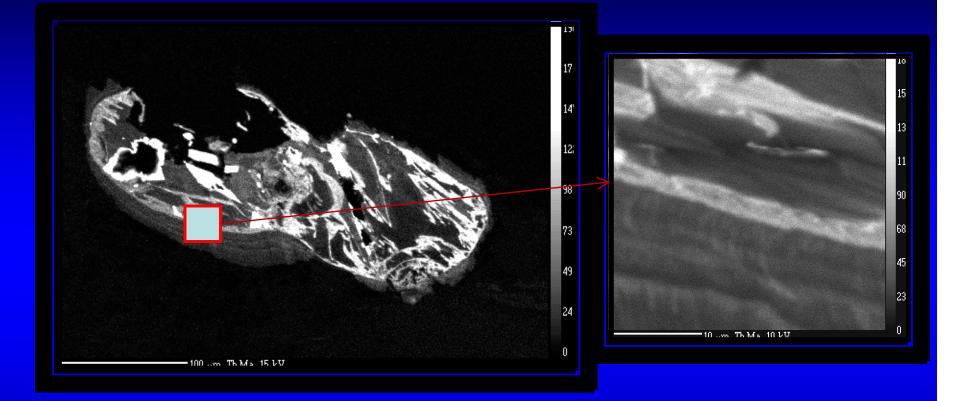




Accuracy = Map!

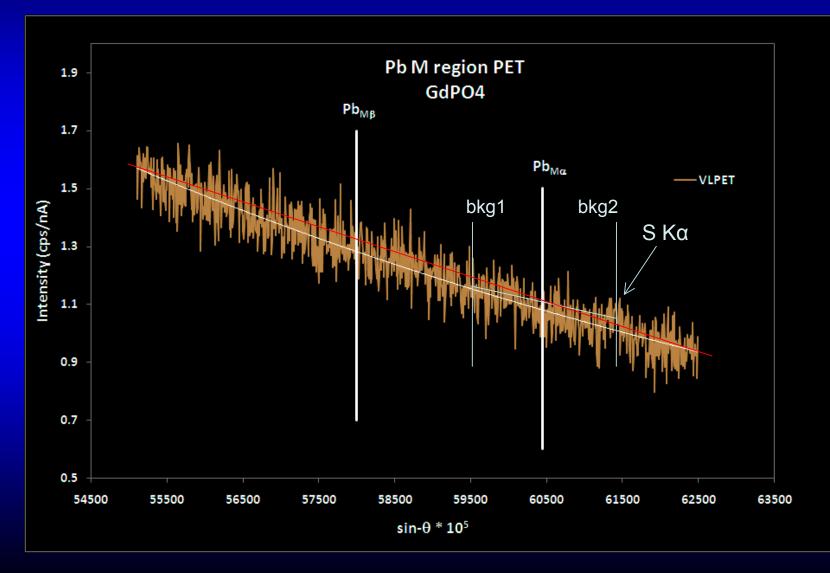
Know the layout of the environment





Accuracy =

High resolution WDS scanning evaluation must be commensurate with the sensitivity of the analysis!

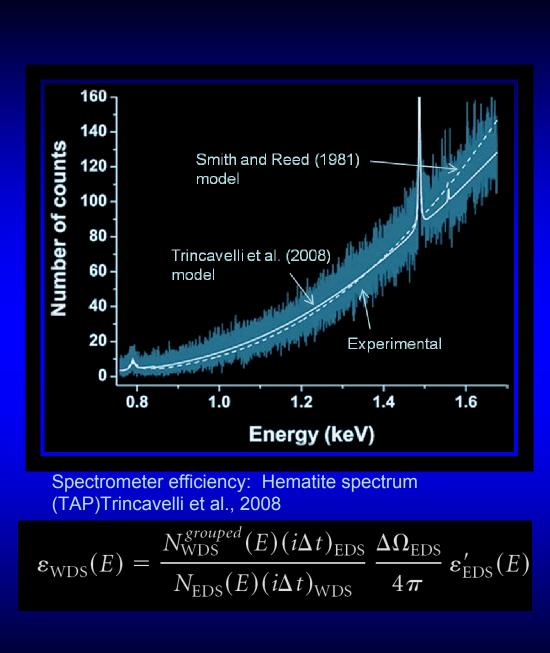


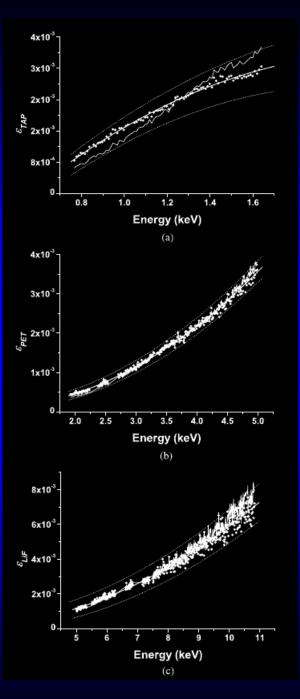
Accuracy =

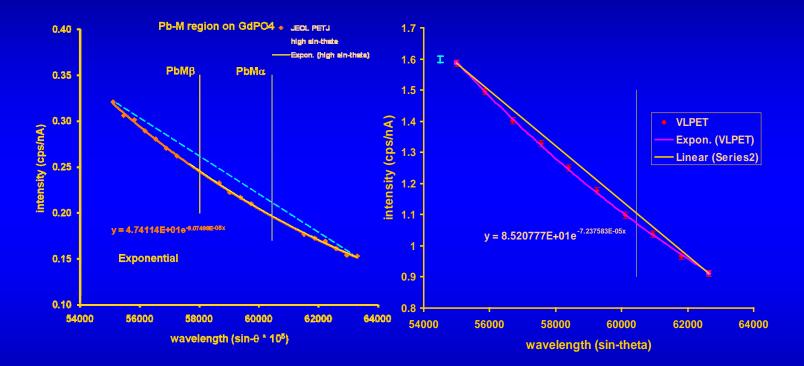
Minimize drift (contamination, dynamic charge effects, source stability, etc.) and beam damage (high current density)

Peak measurement - watch for interferences – peak tails Accurate interference corrections

Background measurement – must account for background shape Spectrometer efficiency Natural Bremmstrahlung Watch for 'holes'

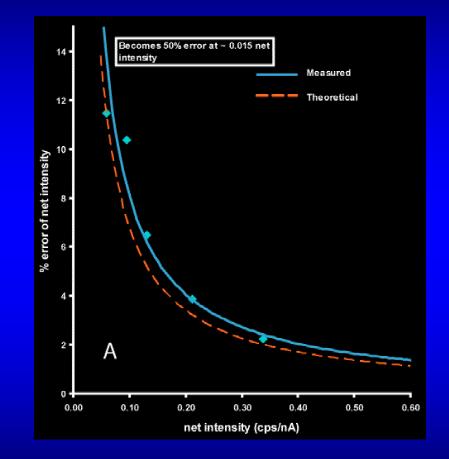




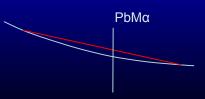


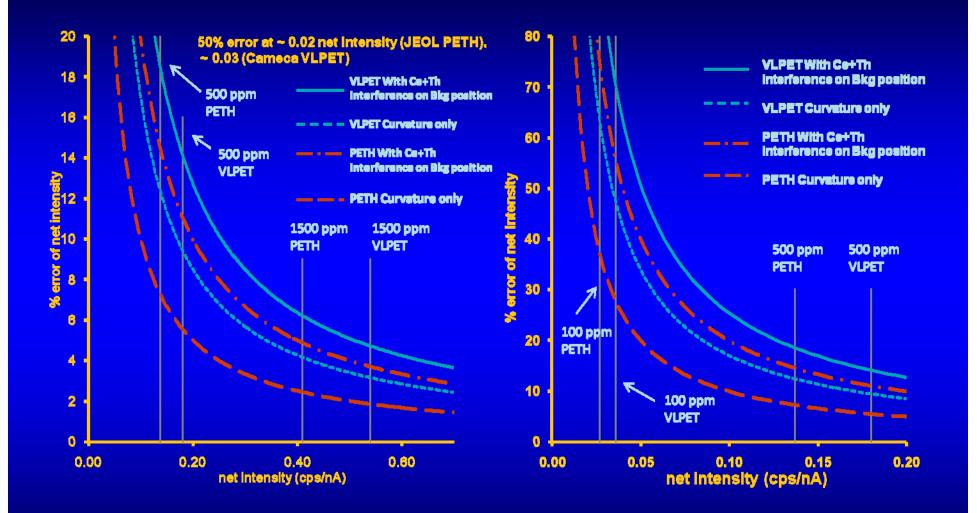
sp3

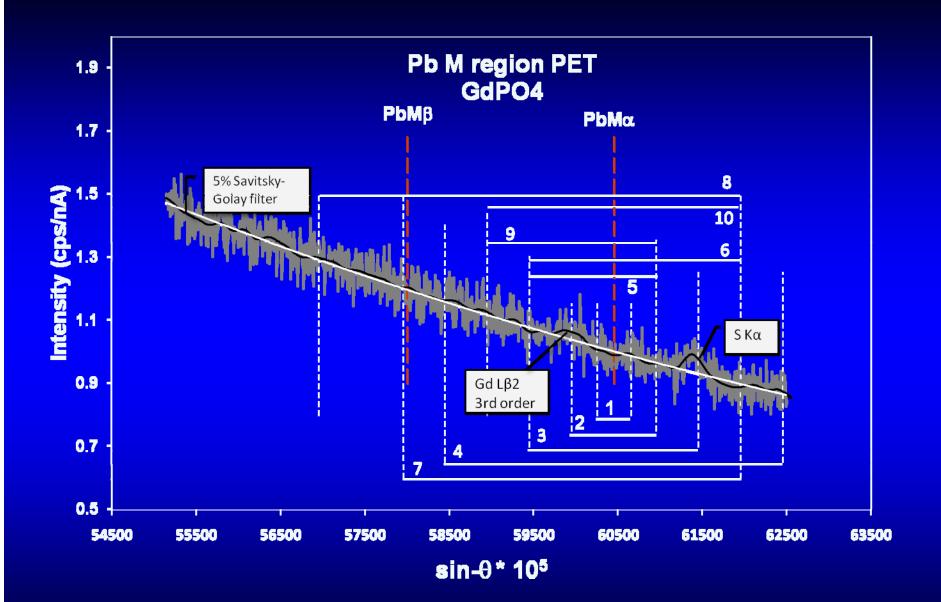
Errors - Background shape

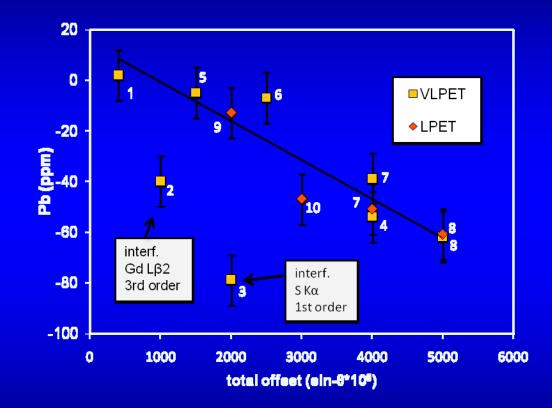


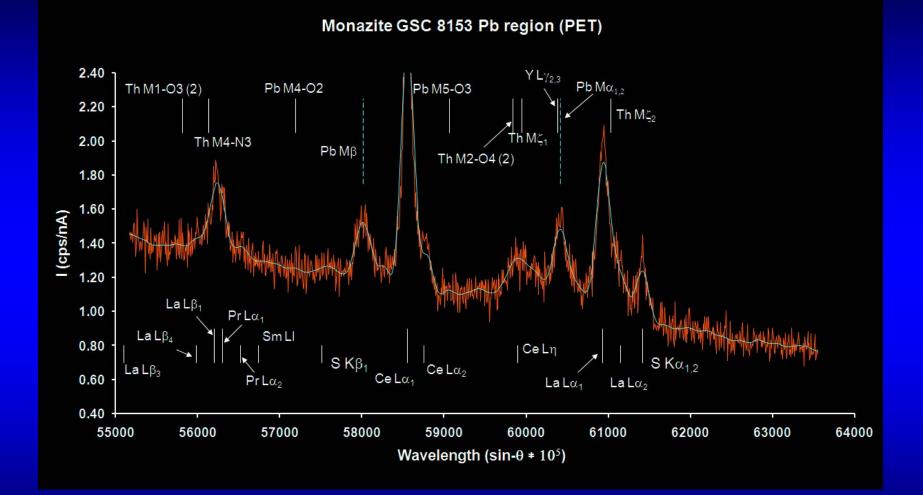
Error due to improper background model for PbMα as peak intensity is lowered (lower concentration)

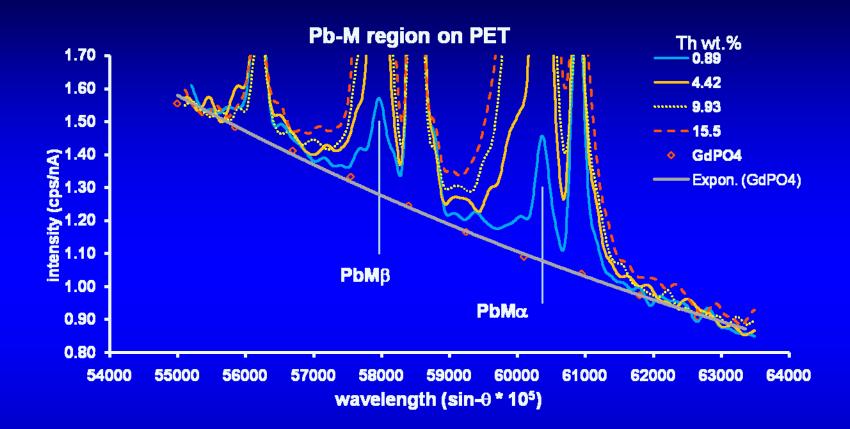


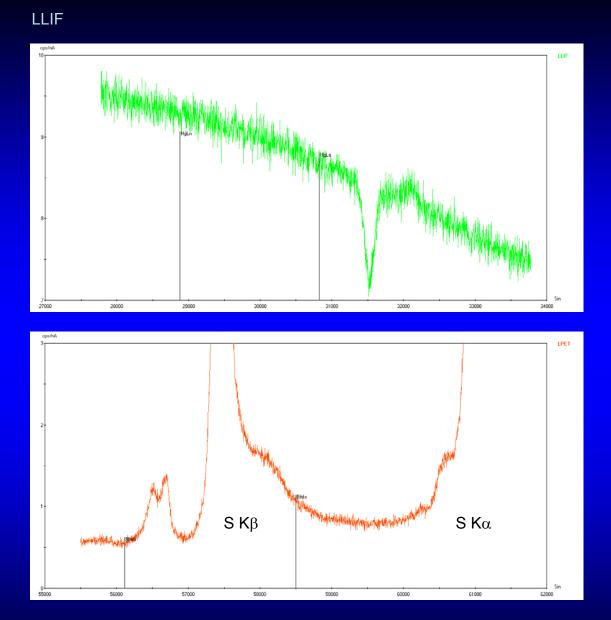








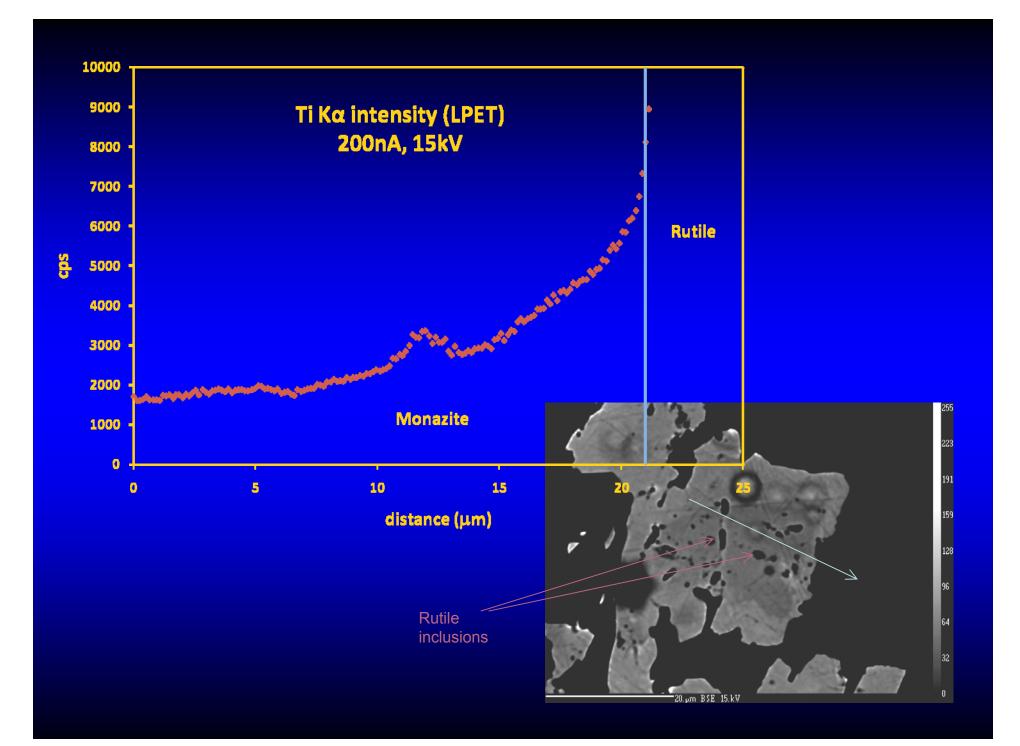




Bi measurement in sulfides and satellites of sulfur diagram lines,

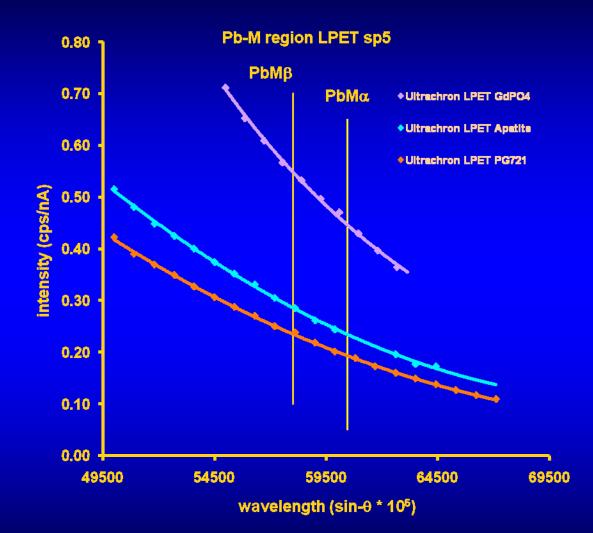
Accuracy =

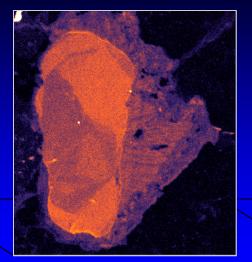
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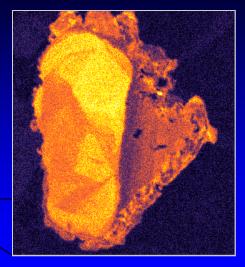
Dependable secondary standards for trace concentrations?

Ion probe? LA-ICP-MS?

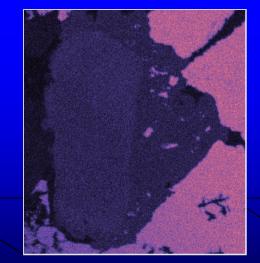




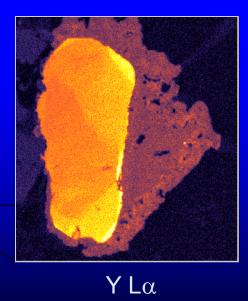
Ca K α



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Th\;M\alpha
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U Μβ



20 µm

